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June 2014

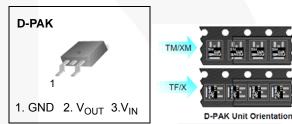
KA78RH33R Low Dropout Voltage Regulator

Features

- Fixed Output Voltage of +3.3 V
- · Space-Saving SMD Types of DPAK
- 1 V (Typical) Dropout at I_O = 800 mA
- · Output Current: 800 mA
- · Thermal Shutdown Protection
- · Over-Current Protection
- Output Trimmed to ±1% Tolerance
- · No Minimum Load Requirement

Description

The KA78RH33 is a +3.3V, fixed, low dropout voltage regulator specifically designed for use in low-voltage operation. The maximum load current is 0.8 A and the dropout voltage is guaranteed to be 1 V (typical). The dropout voltage varies with load current. The regulator consists of composite PNP-NPN pass transistors.



Ordering Information

Part Number	Operating Tem- perature Range	Top Mark	Package	Packing Method
KA78RH33RTF	-25°C to +125°C	KA78RH33	TO-252 3L (DPAK)	Tape and Reel
KA78RH33RTM	-25°C to +125°C	KA78RH33	TO-252 3L (DPAK)	Tape and Reel

^{*} Refer to above unit orientation figure for TM / TF suffix packing.

Block Diagram

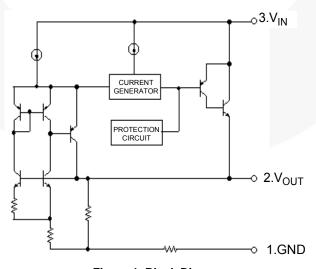


Figure 1. Block Diagram

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Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{IN}	Power Supply Input Voltage	15	V
Io	Output Load Current	800	mA
TJ	Junction Temperature	150	°C
T _{OPR}	Operating Junction Temperature	-25 to 125	°C
T _{STG}	Storage Temperature	-55 to 150	°C

Temperature Characteristics

Symbol	Parameter	Value	Unit
$\Delta V_{O} / \Delta T$	Temperature Coefficient of Output Voltage	±0.02	%/ °C

Thermal Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	110	°C/W

Electrical Characteristics

Refer to the test circuit, values are at V_{IN} = 5 V, C_{O} = 10 μ F, and T_{A} = 25°C,unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{OUT}	Output Voltage	I _O = 10 mA, T _J = 25°C	3.27	3.30	3.33	V
V _{OUT}	Output Voltage	$V_{IN} = 4.8 \text{ V to } 12 \text{ V},$ $I_{O} = 10 \text{ mA to } 800 \text{ mA},$ $T_{J} = -25^{\circ}\text{C to } 125^{\circ}\text{C}$	3.23	3.30	3.37	>
R _{line}	Line Regulation	V_{IN} = 4.8 V to 12 V, I_{O} = 10 mA		1	10	mV
R _{load}	Load Regulation	I _O = 10 mA to 800 mA		1	20	mV
RR	Ripple Rejection	f = 120 Hz, I _O = 500 mA, V _{IN} = 6.3 ± 1 Vrms	55			dB
		I _O = 100 mA		1.00	1.20	
V_{drop}	Dropout Voltage	I _O = 500 mA		1.05	1.25	V
		I _O = 800 mA		1.10	1.40	
Iq	Quiescent Current	V _{IN} ≤ 12 V		5	10	mA
ΔV _O / ΔΤ	Temperature Coefficient of Output Voltage	$T_J = -25^{\circ}\text{C to } 125^{\circ}\text{C},$ $I_O = 10 \text{ mA}$		0.2		mV/°C
I _{pk}	Peak Output Current	V _{IN} = 6.3 V	800			mA
V _n	Output Noise Voltage	f = 10 Hz to 10 kHz		100		μVrms

Typical Application

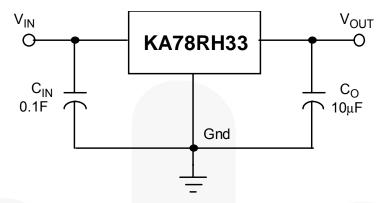


Figure 2. Typical Application⁽¹⁾

Note:

1. An input capacitor, C_{IN} is not necessary for stability, but improves the overall performance.

Physical Dimensions TO-252 3L (DPAK) 6.80 6.40 Α - 5.55 MIN → F 0.90 6.50 MIN 2.90 2.50 С 0.96 MAX (0.64 LAND PATTERN RECOMMENDATION 4.83 MIN (6.80)SEE DETAIL A F 9.80 9.20 ○ 0.10 B **GAGE PLANE** F\1.02 NOTES:UNLESS OTHERWISE SPECIFIED NOT COMPLIANT TO JEDEC TO-252 VARIATION AB ALL DIMENSION ARE IN MILLIMETER DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS 0.127 MAX SEATING PLANE AND THE BAR EATRUSIONS LAD PATTERN PER IPC7351A ATANDARD TO228P991X239-3N DRAWING FILE NAME:MKT-TO252D03REV3. DOES NOT COMPLY JEDEC STANDARD VALUE. FAIRCHILD SEMICONDUCTOR.

Figure 3. 3-Lead, TO-252, JEDEC TO-252 VAR. AB, SURFACE MOUNT (DPAK)

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